

**REMARKS**

Claims 1-35 are pending in the application. Claims 1-35 were subject to the Requirement for Restriction.

***Restriction Requirement***

The Examiner has required restriction to one of the following inventions under 37 C.F.R. 1.499:

- I. Group I, Claims 1-20, drawn to a heater and reflow apparatus.
- II. Group II, Claims 21-27, drawn to a solder bump forming apparatus.
- III. Group III, Claims 28-35, drawn to a method of forming solder bumps.

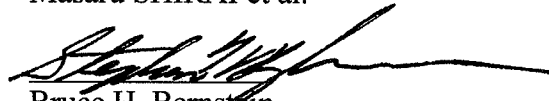
**Election**

In order to be responsive to the requirement for restriction, Applicants elect **Group II (i.e., claims 21 – 27), drawn to a solder bump forming apparatus, without traverse.**

While Applicant elects the invention of Group without traverse, Applicant reserves the right to pursue the subject matter of the remaining Groups in one or more divisional applications. Favorable consideration with early allowance is most earnestly requested.

Should there be any questions, the Examiner is invited to contact the undersigned at the telephone number listed below.

Respectfully Submitted,  
Masaru SHIRAI et al.

  
Bruce H. Bernstein  
Reg. No. 29027

**Stephen M. Roylance**  
**Reg. No. 31,296**

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GREENBLUM & BERNSTEIN, P.L.C.  
1950 Roland Clarke Place  
Reston, VA 20191  
(703) 716-1191